Unit in mm

TOSHIBA Photocoupler GaAs IRed & Photo-Transistor

# 4N38(short),4N38A(short)

AC Line / Digital Logic Isolator.

Digital Logic / Digital Logic Isolator.

Telephone Line Receiver.

Twisted Pair Line Receiver.

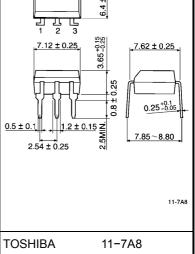
High Frequency Power Supply Feedback Control.

Relay Contact Monitor.

The TOSHIBA 4N38 (short) through 4N38A (short) consists of a gallium arsenide infrared emitting diode coupled with a silicon phototransistor in a dual in-line package.

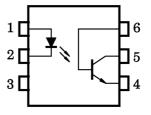
- Switching speeds: 3µs (typ.)
- DC current transfer ratio: 100% (typ.)
- Isolation resistance:  $10^{11}\Omega$  (min.)
- Isolation voltage: 2500Vrms (min.)
- UL recognized: UL1577, file no. E67349

7.12 ± 0.25 7.62 ± 0.25



Weight: 0.4 g

#### Pin Configurations(top view)



1: ANODE

2: CATHODE

3 : N.C.

4 : EMITTER

5: COLLECTOR

6: BASE



## Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
TED	Forward current (continuous)	I <sub>F</sub>	80	mA
	Forward current derating	ΔI <sub>F</sub> / °C	1.07 (*)	mA / °C
	Peak forward current (Note 1)	I <sub>PF</sub>	3	Α
	Power dissipation	PD	150	mW
	Power dissipation derating	ΔP <sub>D</sub> /°C	2.0 (*)	mW / °C
	Reverse voltage	V <sub>R</sub>	3	V
Detector	Collector–emitter voltage	BV <sub>CEO</sub>	80	V
	Collector-base voltage	BV <sub>CBO</sub>	80	V
	Emitter–collector voltage	BV <sub>ECO</sub>	7	V
	Collector current (continuous)	I <sub>C</sub>	100	mA
	Power dissipation	PC	150	mW
	Power dissipation derating	ΔP <sub>C</sub> / °C	2.0 (*)	mW / °C
	Storage temperature	T <sub>stg</sub>	-55~150	°C
Coupled	Operating temperature	T <sub>opr</sub>	-55~100	°C
	Lead soldering temperature (at 10 s)	T <sub>sol</sub>	260	°C
	Total package power dissipation	PT	250	mW
	Total package power dissipation derating	ΔP <sub>T</sub> / °C	3.3 (*)	mW / °C

(Note 1) Pulse width 300µs, 2% duty cycle.

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<sup>(\*)</sup> Above 25°C ambient.

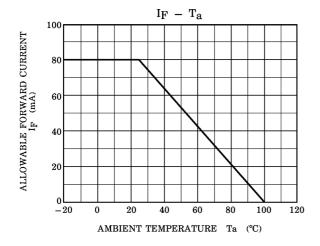


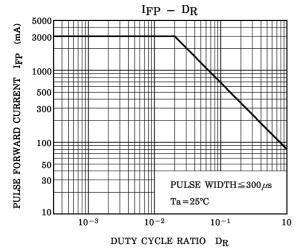
### Electrical Characteristics (Ta = 25°C)

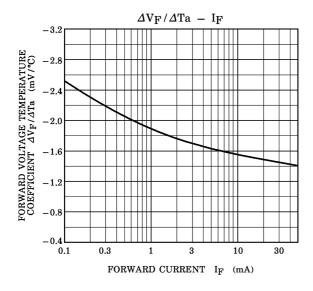
Characteristic			Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage		V <sub>F</sub>	I <sub>F</sub> = 10 mA	_	1.15	1.5	V
	Reverse current		I <sub>R</sub>	V <sub>R</sub> = 3 V	_	_	100	μΑ
	Capacitance		C <sub>D</sub>	V = 0, f = 1 MHz	_	30	_	pF
Detector	DC forward current gain		h <sub>FE</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 500 μA	_	200	_	_
	Collector-emitter breakdown voltage		V (BR) CEO	I <sub>C</sub> = 1 mA	80	_	_	V
	Collector-base breakdown voltage		V (BR) CBO	Ι <sub>C</sub> = 100 μΑ	80	_	_	V
	Emitter-collector breakdown voltage		V (BR) ECO	I <sub>E</sub> = 100 μA	7	_	_	V
	Collector dark current		I <sub>CEO</sub>	V <sub>CE</sub> = 60 V	_	1	50	nA
	Collector dark current		I <sub>CBO</sub>	V <sub>CB</sub> = 60 V	_	0.1	20	nA
	Collector-emitter capacitance		C <sub>CE</sub>	V = 0, f = 1 MHz	_	10	_	pF
Coupled	Current transfer ratio		I <sub>C</sub> / I <sub>F</sub>	I <sub>F</sub> = 10 mA, V <sub>CE</sub> = 10 V	10	100	_	%
	Collector–emitter saturation voltage		V <sub>CE</sub> (sat)	I <sub>F</sub> = 20 mA, I <sub>C</sub> = 4 mA	_	_	1.0	V
	Capacitance input to output		C <sub>S</sub>	V <sub>S</sub> = 0, f = 1 MHz	_	0.8	_	pF
	Isolation resistance		R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	10 <sup>11</sup>	_	_	Ω
			BVS	AC, 1 minute	2500	_	_	Vrms
	Isolation voltage	4N38		AC, peak	1500	_	_	Vpk
		4N38A	BV <sub>S</sub> (*)	AO, peak	2500	_	_	
		4N38A		AC, 1 second	1775	_	_	Vrms
	Turn-on time		t <sub>ON</sub>	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 2 mA	_	3	_	116
	Turn-off time		toff	$R_L = 100\Omega$	_	3	_	μs

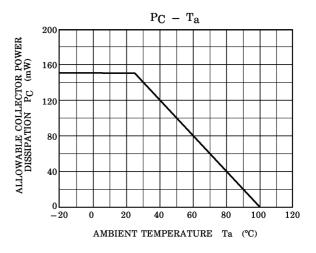
<sup>(\*)</sup> JEDEC registered minimum  $\mbox{BV}_{\mbox{S}},$  however, TOSHIBA specifies a minimum  $\mbox{BV}_{\mbox{S}}$  of 2500 Vrms, 1 minute.

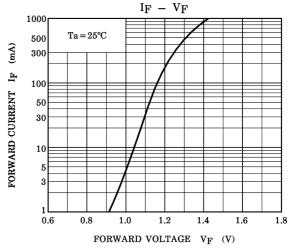
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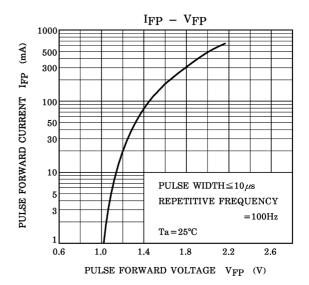


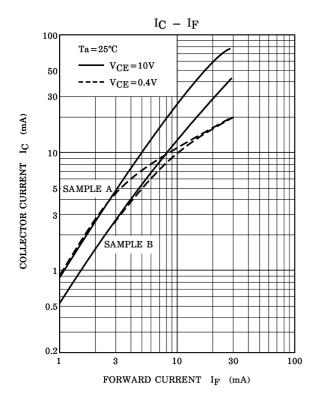


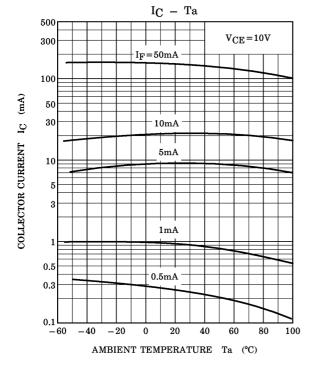


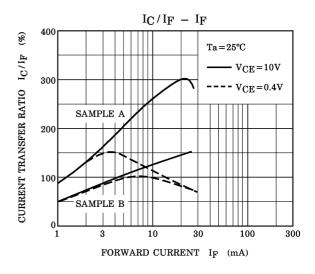


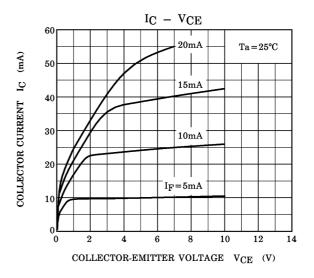


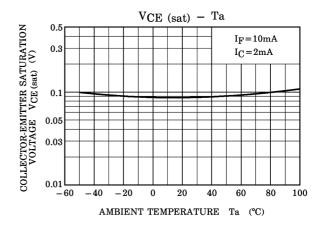


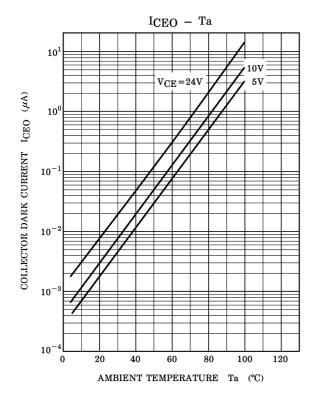


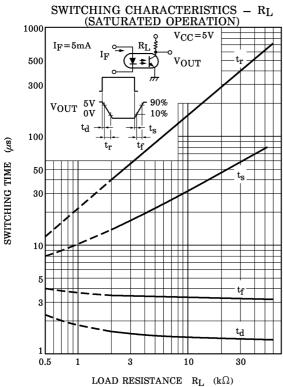


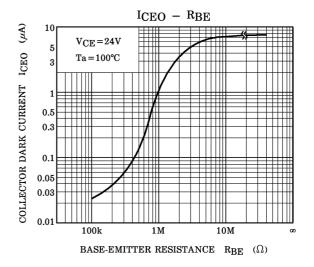


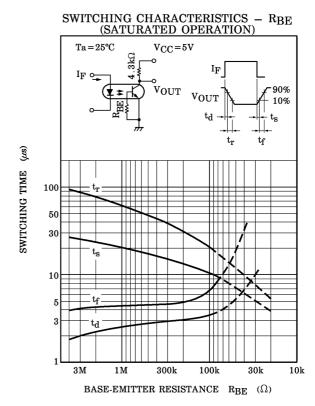












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